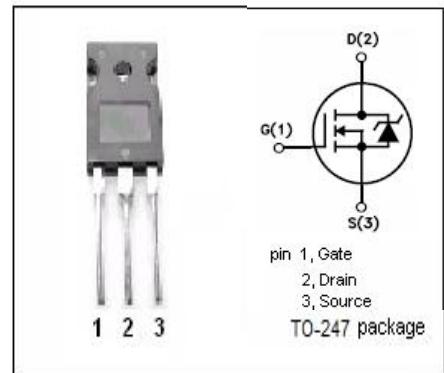


isc N-Channel MOSFET Transistor

IXFH34N65X2
• FEATURES

- With TO-247 packaging
- With low gate drive requirements
- Easy to drive
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation


• APPLICATIONS

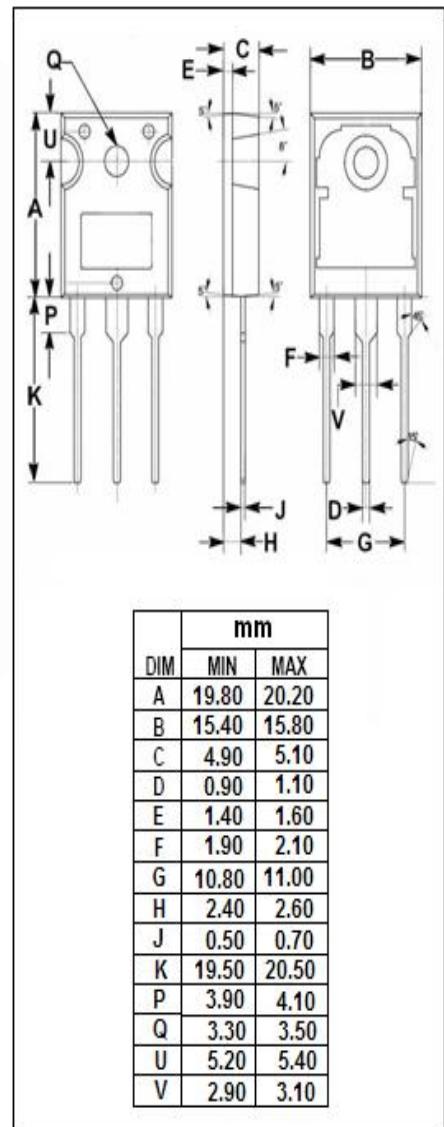
- Switching applications

• ABSOLUTE MAXIMUM RATINGS($T_a=25^\circ\text{C}$)

SYMBOL	PARAMETER	VALUE	UNIT
V_{DSS}	Drain-Source Voltage	650	V
V_{GSS}	Gate-Source Voltage	± 30	V
I_D	Drain Current-Continuous	34	A
I_{DM}	Drain Current-Single Pulsed	68	A
P_D	Total Dissipation	540	W
T_j	Operating Junction Temperature	-55~150	$^\circ\text{C}$
T_{stg}	Storage Temperature	-55~150	$^\circ\text{C}$

• THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
$R_{th(ch-c)}$	Channel-to-case thermal resistance	0.23	$^\circ\text{C}/\text{W}$



isc N-Channel MOSFET Transistor**IXFH34N65X2****ELECTRICAL CHARACTERISTICS** $T_c=25^\circ\text{C}$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
BV_{DSS}	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}; \text{I}_D= 1\text{mA}$	650			V
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\pm 30\text{V}; \text{I}_D=2.5\text{mA}$	3.5		5.0	V
$\text{R}_{\text{DS(on)}}$	Drain-Source On-Resistance	$\text{V}_{\text{GS}}= 10\text{V}; \text{I}_D=17\text{A}$			69	$\text{m}\Omega$
I_{GSS}	Gate-Source Leakage Current	$\text{V}_{\text{GS}}= \pm 30\text{V}; \text{V}_{\text{DS}}= 0\text{V}$			± 0.1	μA
I_{DSS}	Drain-Source Leakage Current	$\text{V}_{\text{DS}}= 650\text{V}; \text{V}_{\text{GS}}= 0\text{V}; @\text{T}_c=25^\circ\text{C}$ $\text{T}_c=125^\circ\text{C}$			10 1750	μA
V_{SDF}	Diode forward voltage	$\text{I}_{\text{SD}}=34\text{A}, \text{V}_{\text{GS}} = 0 \text{ V}$			1.4	V